	TET ESTEL AS ESTONIA	**June 2013**

Series
T143-1250

Phase Control Press-Pack Thyristor Type T143-1250

Center amplifying gate
Low on-state and switching losses
Designed for traction and industrial applications

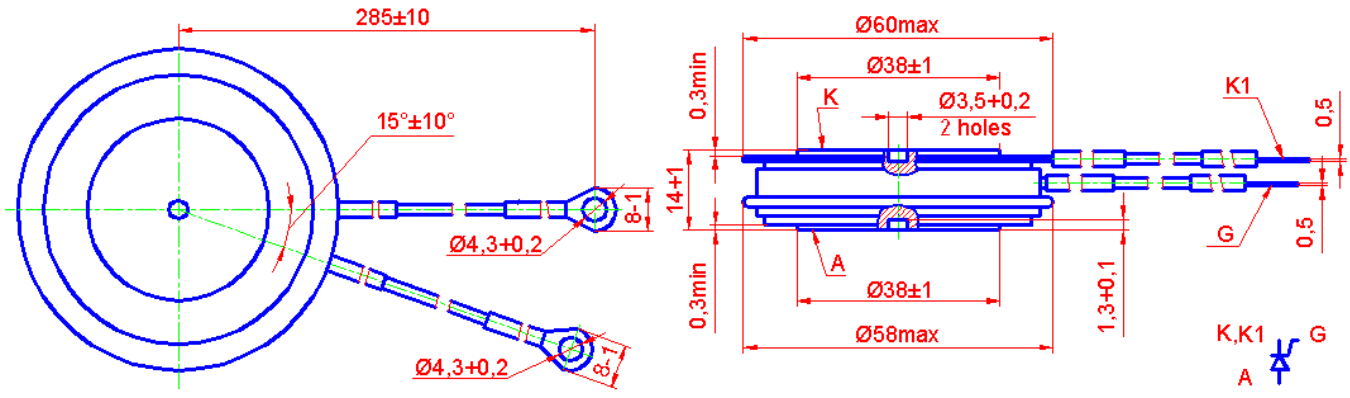
Maximum mean on-state current				I_{TAV}	**1250 A**		
Maximum repetitive peak off-state and reverse voltage				U_{DRM} U_{RRM}	**200 ÷800 V**		
Turn-off time				**tq**	**125; 160; 200; 250 µs**		
U_{DRM}, U_{RRM}, V	200	300	400	500	600	700	800
Voltage code	2	3	4	5	6	7	8
Tvj, °C	- 60 ÷ 140						

MAXIMUM ALLOWABLE RATINGS				
Symbols and parameters		Units	T143-1250	Conditions
I_{TAV}	Mean on-state current	A	1250 1655	Tc=83 °C, Tc=55 °C, 180° half-sine wave, 50 Hz
I_{TRMS}	RMS on-state current	A	1960	Tc=83 °C
I_{TSM}	Surge on-state current	kA	20 22	Tvj=140°C Tvj=25°C tp=10 ms U_R=0
I^2t	Limiting load integral	kA^2s	2000 2420	Tvj=140°C Tvj=25°C
U_{DRM},U_{RRM}	Repetitive peak off-state and reverse voltage	V	200÷800	Tj min≤Tvj≤Tjm 180° half-sine wave, 50 Hz Gate open
U_{DSM},U_{RSM}	Non-repetitive peak off-state and reverse voltage	V	300÷900	Tj min≤Tvj≤Tjm 180° half-sine wave tp=10 ms, Single pulse Gate open
(di$_T$/dt) crit	Critical rate of rise of on-state current : non - repetitive repetitive	A/µs	 400 200	Tvj=140°C ; U_D=0,67 U_{DRM}, Gate pulse : 10V,5 Ω, 1µs rise time, 10 µs
U_{RGM}	Peak reverse gate voltage	V	5	Tj min≤Tvj≤Tjm
Tstg	Storage temperature	°C	-60÷80	
Tvj	Junction temperature	°C	-60÷140	
CHARACTERISTICS				
U_{TM}	Peak on-state voltage	V	1,6	Tvj=25°C, I_{TM}=3,14 I_{TAV}
$U_{T(TO)}$	Threshold voltage	V	0,95	Tvj=140°C 1,57 I_{TAV}< I_T <4,71 I_{TAV}
R_T	On-state slope resistance	mΩ	0,2	
I_{DRM} I_{RRM}	Repetitive peak off-state and reverse current	mA	 80 80	Tvj=140°C, U_D = U_{DRM} U_R= U_{RRM}

CHARACTERISTICS					
Symbols and parameters		Units	T143-1250	Conditions	
I_L	Latching current	A	1	Tvj=25°C,U_D=12V Gate pulse : 10V, 5Ω, 1 µs rise time, 10µs	
I_H	Holding current	A	0,5	Tvj=25°C,U_D=12V, Gate open	
U_{GT}	Gate trigger direct voltage	V	2,5 5,0	Tvj=25°C, Tvj=-60°C	U_D=12V
I_{GT}	Gate trigger direct current	A	0,3 0,85	Tvj=25°C, Tvj=-60°C	
U_{GD}	Gate non-trigger direct voltage	V	0,25	Tvj=140°C, U_D = 0,67 U_{DRM}	
I_{GD}	Gate non-trigger direct current	mA	10	Direct gate current	
t_{gd}	Delay time	µs	3,2	Tvj=25°C,U_D=500V I_{TM} = 1250 A Gate pulse : 10V, 5Ω, 1 µs rise time, 10µs	
t_{gt}	Turn-on time	µs	6,3		
tq	Turn-off time	µs	125÷250	Tvj=140°C, I_{TM}=1250 A di_R/dt =10 A/µs, U_R=100V U_D = 0,67 U_{DRM} du_D/dt=50 V/µs	
Qrr	Recovered charge	µC	1900	Tvj=140°C, I_{TM}=1250 A di_R/dt=10 A/µs, U_R=100V	
trr	Reverse recovery time	µs	27		
I_{RRM}	Peak reverse recovery current	A	140		
$(du_D/dt)_{crit}$	Critical rate of rise of off-state voltage	V/µs	500 1000	Tvj=140°C, U_D = 0,67 U_{DRM} Gate open	
Rthjc	Thermal resistance junction to case	°C/W	0,029	Direct current, double side cooled	

ORDERING							
	T	**143**	**1250**	**6**	**7**	**2**	
	1	**2**	**3**	**4**	**5**	**6**	

1. Phase control thyristor.
2. Design version.
3. Mean on-state current, A.
4. Voltage code (6=600 V).
5. Critical rate of rise of off-state voltage (6 ≥ 500 V/µs, 7 ≥ 1000 V/µs).
6. Group of turn-off time (du_D/dt=50 V/µs, 2 ≤ 250 µs, P2 ≤ 200 µs, 3 ≤ 160 µs, X2 ≤ 125 µs).



Mounting force : 13÷19 kN
Weight : 210 grams